

STARPOWER

SEMICONDUCTOR

IGBT

GD600HFX75C6H

750V/600A 2 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as inverters and UPS.

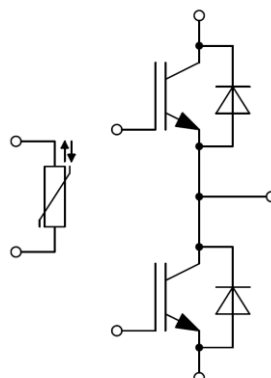
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- $V_{CE(sat)}$ with positive temperature coefficient
- 3 μ s short circuit capability
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
V_{CES}	Collector-Emitter Voltage	750	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C = 25^{\circ}\text{C}$ @ $T_C = 80^{\circ}\text{C}$	841 600	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1200	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	2143	W

Diode

Symbol	Description	Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	750	V
I_F	Diode Continuous Forward Current	600	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1200	A

Module

Symbol	Description	Values	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	2500	V

IGBT Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.30	1.75	V
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		1.45		
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=175^{\circ}\text{C}$		1.50		
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		1.65		
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=175^{\circ}\text{C}$		1.70		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=9.60\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.1	5.8	6.5	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			0.67		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		42.3		nF
C_{res}	Reverse Transfer Capacitance			1.56		nF
Q_G	Gate Charge	$V_{GE}=-15 \dots +15\text{V}$		3.96		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/15\text{V}, L_S=40\text{nH}, T_j=25^{\circ}\text{C}$		175		ns
t_r	Rise Time			78		ns
$t_{d(off)}$	Turn-Off Delay Time			558		ns
t_f	Fall Time			77		ns
E_{on}	Turn-On Switching Loss			16.7		mJ
E_{off}	Turn-Off Switching Loss			23.0		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/15\text{V}, L_S=40\text{nH}, T_j=150^{\circ}\text{C}$		179		ns
t_r	Rise Time			82		ns
$t_{d(off)}$	Turn-Off Delay Time			627		ns
t_f	Fall Time			164		ns
E_{on}	Turn-On Switching Loss			23.4		mJ
E_{off}	Turn-Off Switching Loss			28.3		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/15\text{V}, L_S=40\text{nH}, T_j=175^{\circ}\text{C}$		181		ns
t_r	Rise Time			86		ns
$t_{d(off)}$	Turn-Off Delay Time			647		ns
t_f	Fall Time			184		ns
E_{on}	Turn-On Switching Loss			24.6		mJ
E_{off}	Turn-Off Switching Loss			28.8		mJ
I_{SC}	SC Data	$t_p \leq 3\mu\text{s}, V_{GE}=15\text{V}, T_j=175^{\circ}\text{C}, V_{CC}=400\text{V}, V_{CEM} \leq 750\text{V}$		2600		A

Diode Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_C=450\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.45	1.90	V
		$I_C=450\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.40		
		$I_C=450\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.35		
		$I_C=600\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.50		
		$I_C=600\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.50		
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=5500\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=40\text{nH}, T_j=25^{\circ}\text{C}$		19.9		μC
I_{RM}	Peak Reverse Recovery Current			219		A
E_{rec}	Reverse Recovery Energy			10.8		mJ
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=4950\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=40\text{nH}, T_j=150^{\circ}\text{C}$		37.8		μC
I_{RM}	Peak Reverse Recovery Current			281		A
E_{rec}	Reverse Recovery Energy			15.4		mJ
Q_r	Recovered Charge	$V_R=400\text{V}, I_F=450\text{A},$ $-di/dt=4850\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=40\text{nH}, T_j=175^{\circ}\text{C}$		42.4		μC
I_{RM}	Peak Reverse Recovery Current			294		A
E_{rec}	Reverse Recovery Energy			16.8		mJ

NTC Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		20		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		1.10		m Ω
R_{thJC}	Junction-to-Case (per IGBT) Junction-to-Case (per Diode)			0.070 0.114	K/W
R_{thCH}	Case-to-Heatsink (per IGBT) Case-to-Heatsink (per Diode) Case-to-Heatsink (per Module)		0.029 0.047 0.009		K/W
M	Terminal Connection Torque, Screw M6 Mounting Torque, Screw M5	3.0 3.0		6.0 6.0	N.m
G	Weight of Module		350		g

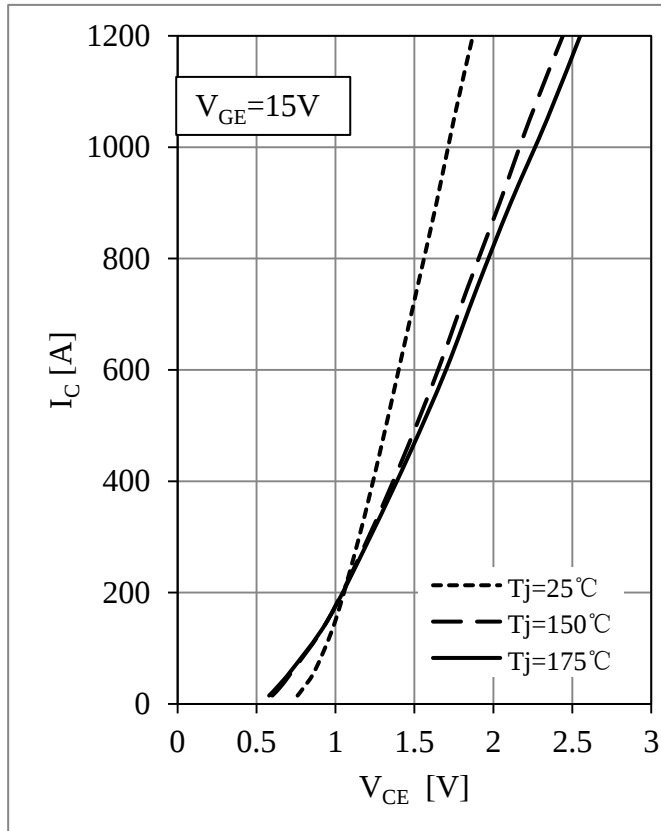


Fig 1. IGBT Output Characteristics

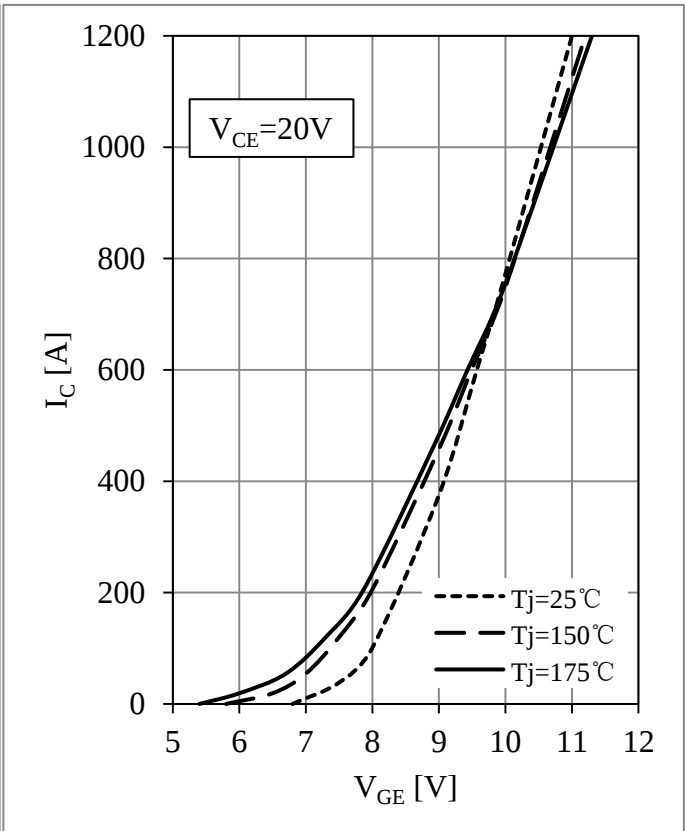
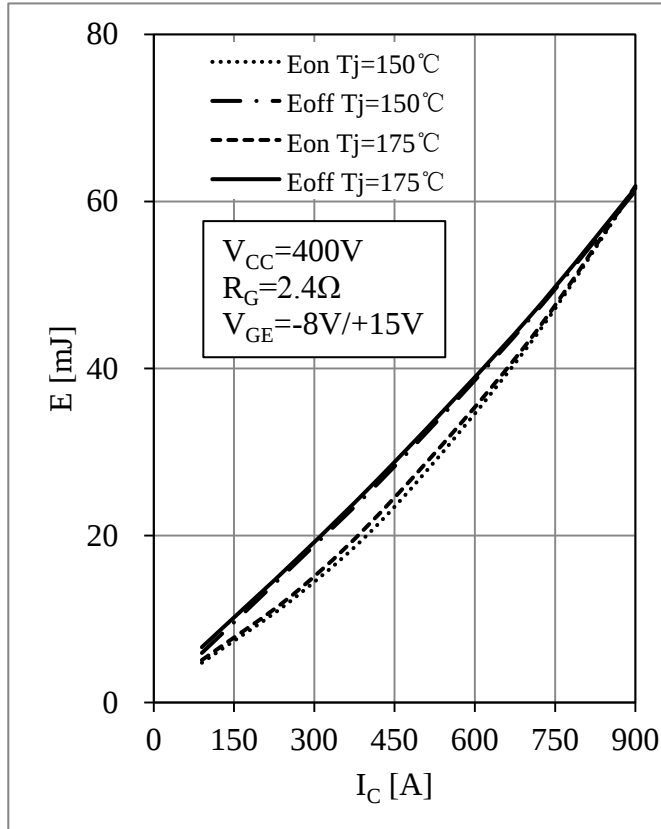
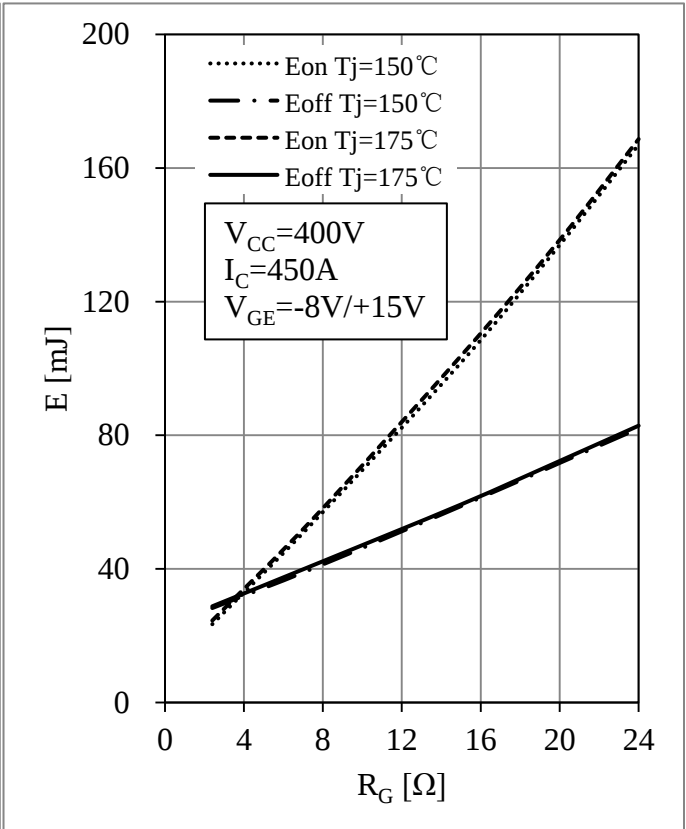


Fig 2. IGBT Transfer Characteristics

Fig 3. IGBT Switching Loss vs. I_C Fig 4. IGBT Switching Loss vs. R_G

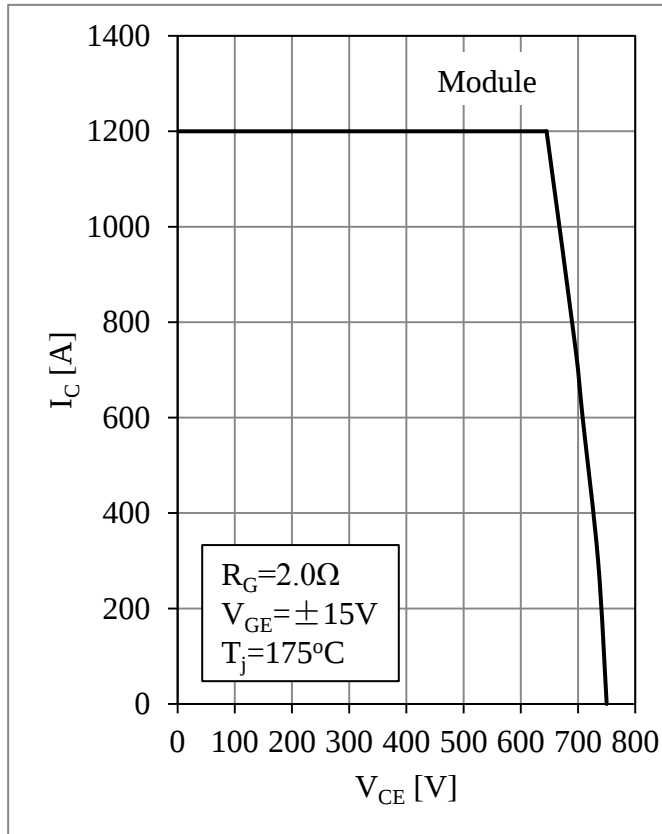


Fig 5. RBSOA

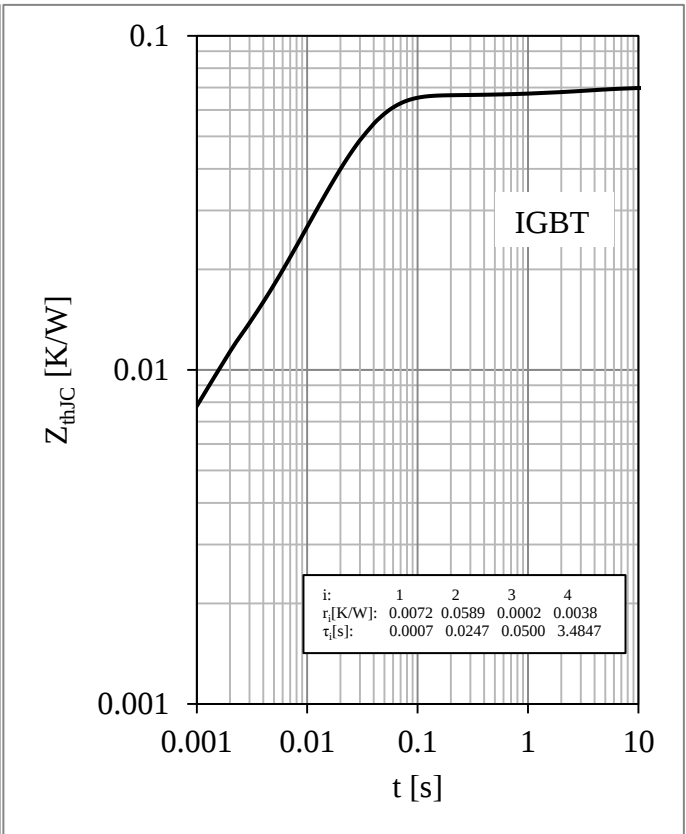


Fig 6. IGBT Transient Thermal Impedance

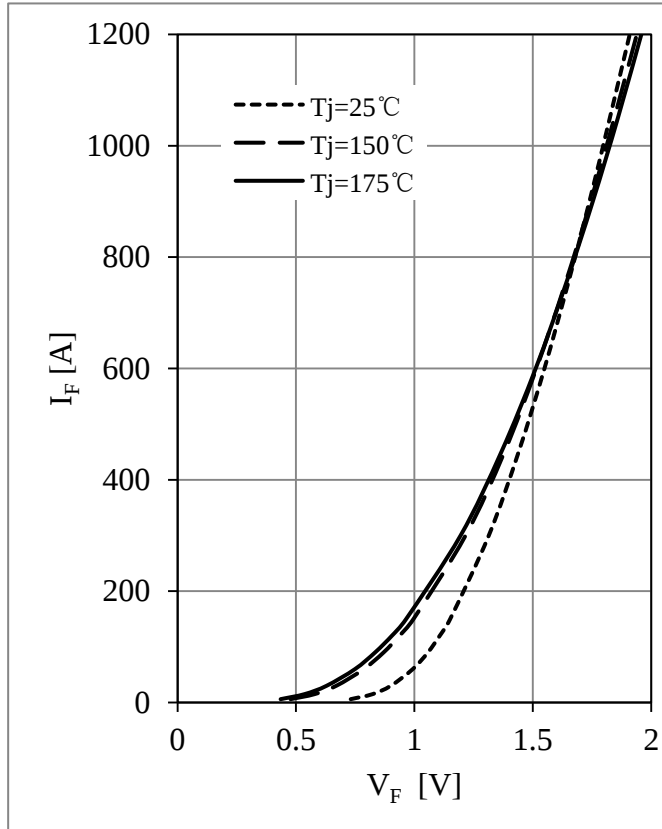
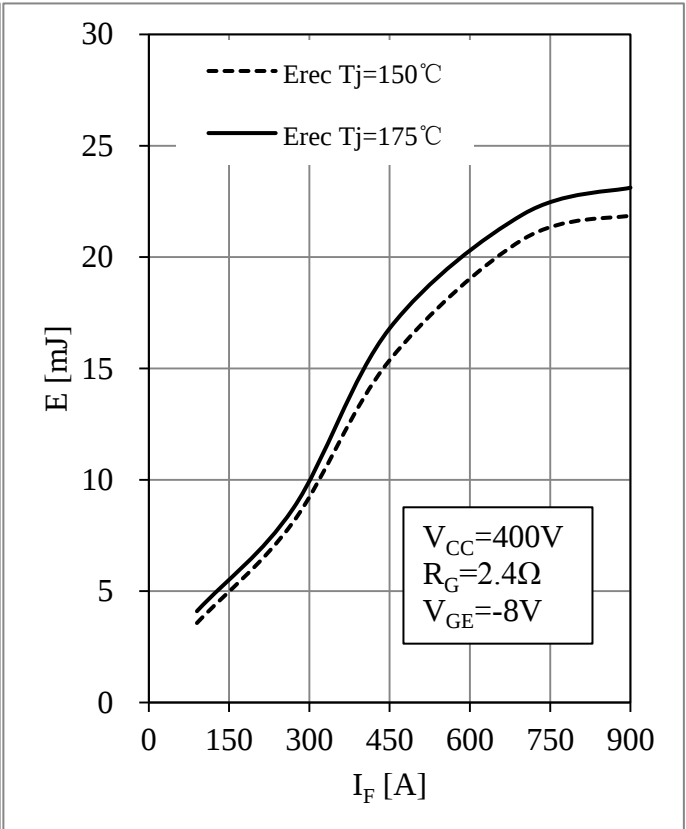


Fig 7. Diode Forward Characteristics

Fig 8. Diode Switching Loss vs. I_F

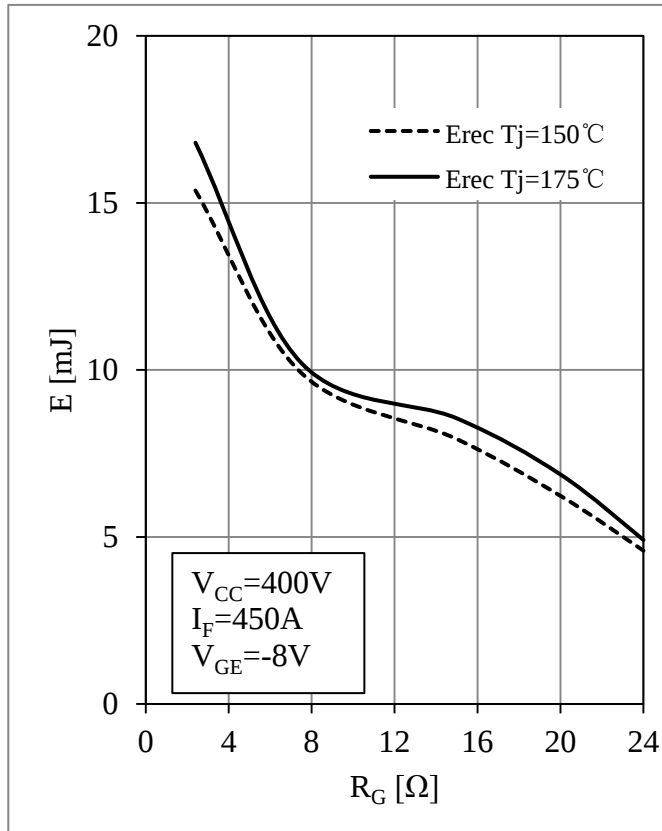
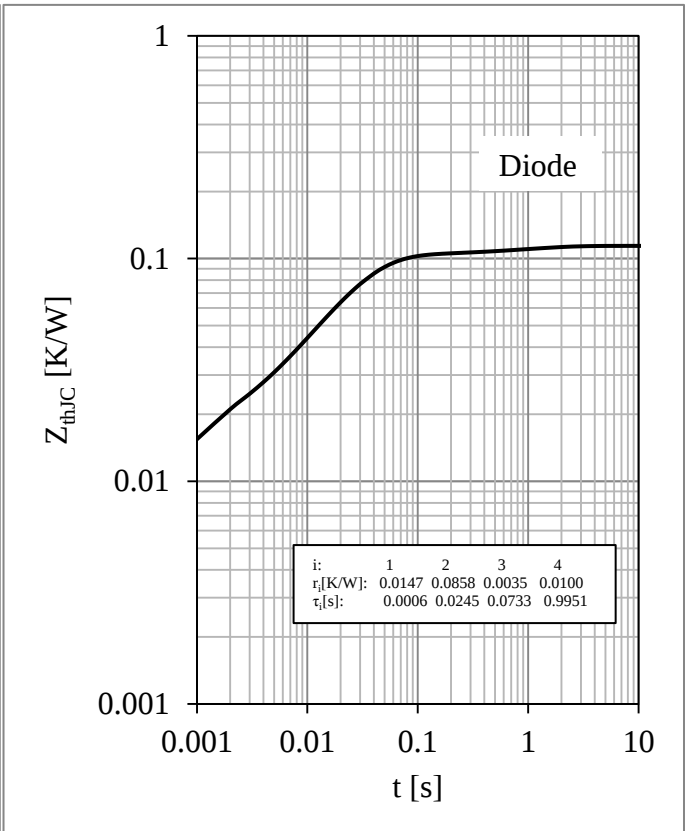
Fig 9. Diode Switching Loss vs. R_G 

Fig 10. Diode Transient Thermal Impedance

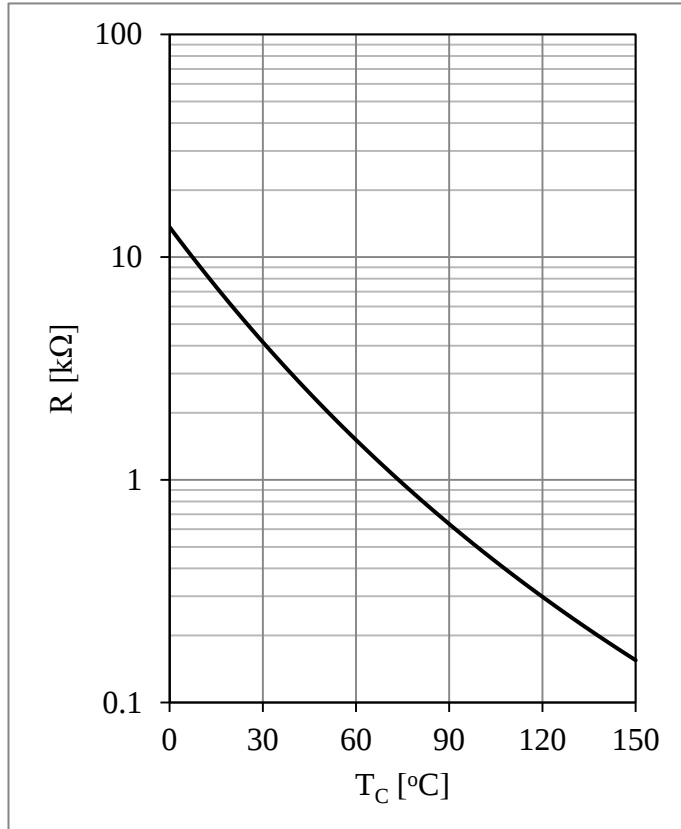
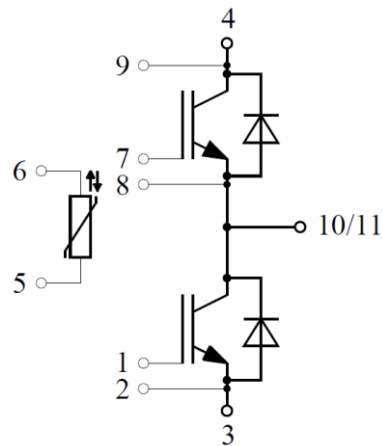


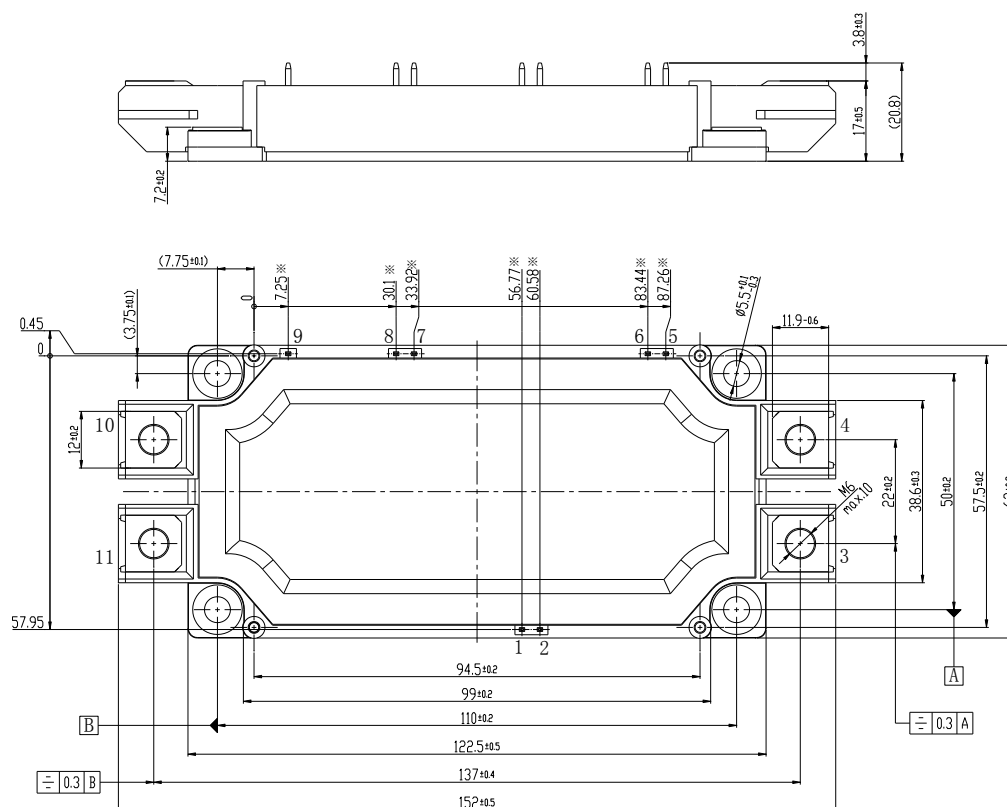
Fig 11. NTC Temperature Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



※: all dimensions with a tolerance of ± 0.05
dimensions valid in mounted condition

Terms and Conditions of Usage

The data contained in this product datasheet is exclusively intended for technically trained staff. you and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see www.powersemi.cc), For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

If and to the extent necessary, please forward equivalent notices to your customers.
Changes of this product data sheet are reserved.